

#### **Features and Benefits**

- Compact Size and Weight
   Greater than 10X reduction over
   traditional technologiess
- Near Ideal Performance

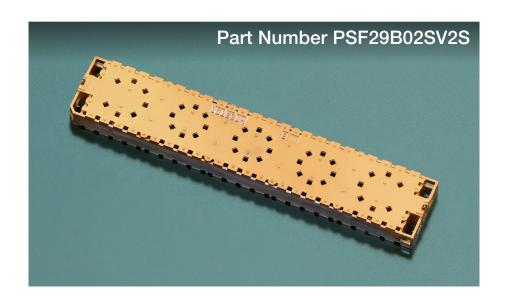
   Higher rejection and flatter passbands
- Precision

   Low part-to-part variation
- Ease of Assembly
   Standard SMT processes
- Lower System BOM Cost

   Eliminate extra gain stages and signal cleanup

#### **Applications**

- Metrology
- RF Telemetry
- Meterology
- Instrumentation
- 5G Backhaul
- Satellite Communications



## Ka Band Bandpass Filter

# Surface mount millimeter-wave bandpass filter with unrivaled rejection and flatness — in a miniature form factor.

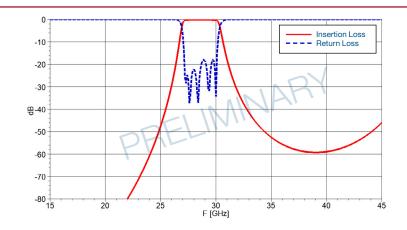
#### **Description**

Nuvotronics PolyStrata® Technology provides high performance filtering in a small form factor. This surface-mount interdigital filter provides high frequency performance with unparalleled flatness.

This PSF29B02SV2S part has a passband of 27.5 GHz – 30 GHz with a characteristic impedance of 50  $\Omega$ . The high power, low loss performance of this part is ideal for space or ground applications. This part is compliant with RoHS standards. Tape and reel packaging is available for bulk orders.

#### **Typical Electrical Performance**

Parameter	Value
Insertion Loss, 27.5 GHz to 30 GHz	< 0.5 dB
Return Loss, 27.5 GHz to 30 GHz	>15 dB
Rejection at 0 to 16.9 GHz	> 50 dB
Rejection at 16.9 to 17.8 GHz	> 60 dB
Rejection at 17.8 to 20.2 GHz	> 60 dB
Rejection at 20.2 to 21.2 GHz	> 55 dB
Rejection at 31.3 to 31.8 GHz	> 20 dB
Rejection at 42.5 GHz	> 50 dB



Cubic Mission Solutions SPECIFICATION SHEET | P/N 1018314



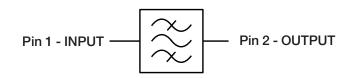
#### **Additional Details**

Special Handling / Storage Instructions		
Storage	IAW IPC-4553A	
EDS Sensitivity	None	
Moisture Sensitivity	MSL3	
Ordering Information	1018314	
Standard Packaging	Tape and Reel Conforms to BCA173-A	
Alternative Packaging Available	Gel-coated Substrate Carrier Waffle pack	
<b>Component Termination Finish</b>	Immersion Silver	

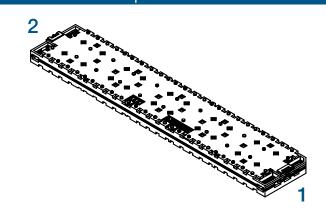
#### **Absolute Maximum Ratings**

Power	2W CW
Operating Temp	0°C to 55°C
Solder Reflow	260°C max. for 10 seconds, 3 cycles
Epoxy Attach	150°C max. for 90 minutes

## Simplified Block Diagram



## Component View



### **PCB** Layout



## Mechanical Drawing



**Bottom View** 

